CH03-DD - SIM CARD HOLDER WITHOUT SWITCH 6 OR 8 PINS PUSH PUSH TYPE

FEATURES
1. GENERAL CHARACTERISTICS
   DIMENSIONS: 27.55L x 18.70W x 1.90H mm
   WEIGHT: APPROX. 1.38g
   CONTACT PRINCIPLE: FRICTION TECHNOLOGY
   OPERATING POSITIONS: SHAFT UP / DOWN / HORIZONTAL
   MOUNTING SYSTEM: SMT TYPE (without post)
   FUNCTION: PUSH PUSH TYPE
   DURABILITY: 5,000 CYCLES MIN.

2. MECHANICAL CHARACTERISTICS
   INSULATION MATERIAL: THERMOPLASTIC, UL 94V-0
   ROHS DIRECTIVE 2002/95/EC COMPLIANT

3. ELECTRICAL CHARACTERISTICS
   NUMBER OF CONTACTS: 6, 8 PINS (OPTIONAL)
   CONTACT RESISTANCE: 50 OHMS MAX.
   INSULATION RESISTANCE: 1000 OHMS / 500V DC

4. SOLDERABILITY
   WAVE: NOT APPLICABLE
   IR REFLOW: 260°C, 10 SEC. MAX.
   MANUAL SOLDERING: 360°C, 3 SEC. MAX.

5. ENVIRONMENTAL CHARACTERISTICS
   OPERATING TEMPERATURE: -40°C - +85°C
   OPERATING HUMIDITY: 10% - 95% RH
   STORAGE TEMPERATURE: -40°C - +85°C
   STORAGE HUMIDITY: 10% - 95% RH

NOTES:
1. ACCEPTABLE SIM CARD SIZE SHOULD MEET GSM 11.11 SPECIFICATION REQUIREMENT.

HOW TO ORDER

<table>
<thead>
<tr>
<th>CH03-DDXX0-B</th>
<th>NO. OF CONTACTS</th>
<th>WITH/OUT SWITCH</th>
<th>WITH/OUT LOCATING FEG</th>
<th>REEL PACKAGING</th>
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<tbody>
<tr>
<td>06 OR 08</td>
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<td>6000 PCS PER REEL</td>
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Drawing Number: CH03-DD-B
Sheet 1 of 1
Revision: 1.2
Unit: mm

RoHs Compliant